



SPECIFICATIONS

CUSTOMER	:	CFR015
SAMPLE CODE	:	SH320240T-022-I-Q
MASS PRODUCTION CODE	:	PH320240T-022-I-Q
SAMPLE VERSION	:	02
SPECIFICATIONS EDITION	:	006
DRAWING NO. (Ver.)	:	LMD-PH320240T-022-I-Q (Ver.002)
PACKAGING NO. (Ver.)	:	PKG-PH320240T-022-I-Q (Ver.001)

Customer Approved

Date:

Approved	Checked	Designer
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- Preliminary specification for design input
- Specification for sample approval

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History of Version

Date	Ver.	Edi.	Description	Page	Design by
07/01/2011	01	001	New Drawing.	-	Poly
09/29/2011	01	002	New Sample	-	Poly
07/27/2012	02	003	Second Sample Modify TFT LCD Modify Optical Characteristics	- - 7	Yuan
2014/03/28	02	004	Modify Optical Characteristics Modify Drawing	6 Appendix	Yuan
08/18/2015	02	005	Show Backlight Life Time	9	劉進
01/28/2016	02	006	Update Timing Characteristics	14-19	劉進

Total: 33 Page

Contents

1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics

2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics
- 2.4 Programming Init code

3. QUALITY ASSURANCE SYSTEM

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

4. RELIABILITY TEST

- 4.1 Reliability Test Condition

5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Appendix : 1. LCM Drawing
2. LCM Packaging Specifications

Note : For detailed information please refer to IC data sheet :

Primacy(TFT LCD): SSD2119

1. SPECIFICATIONS

1.1 Features

Main LCD Panel

Item	Standard Value
Display Type	320* (R、G、B) * 240 Dots
LCD Type	a-Si TFT , Normally White , TN mode , Transmissive type
Screen size (inch)	3.5 inch
Viewing Direction	6 O'clock
Color configuration	R.G.B. vertical stripe
Backlight	LED B/L
Driver IC	SSD2119 (262K Colors)
Interface	1. 8/ 9/ 16/ 18-bit 6800-series /8080-series Parallel Interface. 2. Serial Peripheral Interface (SPI). 3. 18-/6-bit RGB interface (DEN,DOTCLK, HSYNC, VSYNC, DB[17:0]). 4. VSYNC interface (system interface + VSYNC). 5. WSYNC interface (system interface + WSYNC).
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer website : http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	76.9 (W) * 63.9(L) * 3.5(H)(MAX)	mm

LCD Panel

Item	Standard Value	Unit
Active Area	70.08 (W) * 52.56 (L)	mm

Note : For detailed information please refer to LCM drawing.



1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDDIO	VSS	-0.3	+4.0	V
Input Voltage	VCI	-	-0.3	+5.0	V
Operating Temperature	T _{OP}	-	-20	+70	°C
Storage Temperature	T _{ST}	-	-30	+80	°C
Storage Humidity	H _D	Ta < 60 °C	20	90	%RH



1.4 DC Electrical Characteristics

Module

VSS = 0V, Ta = 25°C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Power Supply Voltage	VDDIO	-	3.0	3.3	3.6	V
Input High Voltage	V _{IH1}	-	0.8* VDDIO	-	VDDIO	V
Input Low Voltage	V _{IL1}	-	0	-	0.2* VDDIO	V
Output High Voltage	V _{OH1}	I _{OH} =-0.1mA	0.9 * VDDIO	-	VDDIO	V
Output Low Voltage	V _{OL1}	I _{OL} =0.1mA	0	-	0.1* VDDIO	V
Supply Current	IDDIO+ICI	VDDIO/VCI = 3.3 V Pattern= picture	-	7	-	mA
		VDDIO/VCI = 3.3 V Pattern= Black *1	-	9.5	14.3	mA

Note1 : Maximum current display.

1.5 Optical Characteristics

TFT LCD Panel

VDDIO =3.3V, Ta=25°C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	-
Response time	Tr + Tf	-	-	30	45	ms	Note2
Viewing angle	Top	$\theta Y+$	-	60	-	Deg.	Note4
	Bottom	$\theta Y-$	-	60	-		
	Left	$\theta X-$	-	60	-		
	Right	$\theta X+$	-	60	-		
Contrast ratio	CR	-	500	600	-	-	Note3
Color of CIE Coordinate (With B/L)	White	X	0.26	0.31	0.36	-	Note1
		Y	0.29	0.34	0.39		
	Red	X	0.58	0.63	0.68		
		Y	0.29	0.34	0.39		
	Green	X	0.28	0.33	0.38		
		Y	0.55	0.60	0.65		
	Blue	X	0.10	0.15	0.20		
		Y	0.03	0.08	0.13		
Average Brightness Pattern=white display	IV	IF= 20 mA	220	250	-	cd/m ²	Note1
Uniformity	ΔB	-	70	-	-	%	Note1

Note1:

1 : $\Delta B = B(\text{min}) / B(\text{max}) \times 100\%$

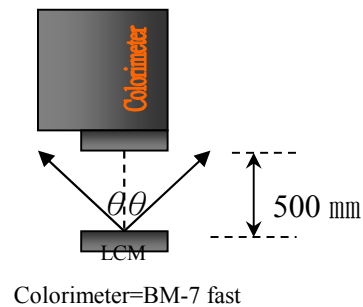
2 : Measurement Condition for Optical Characteristics:

a : Environment: 25°C±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: 500 ± 50 mm , ($\theta = 0^\circ$)

c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.

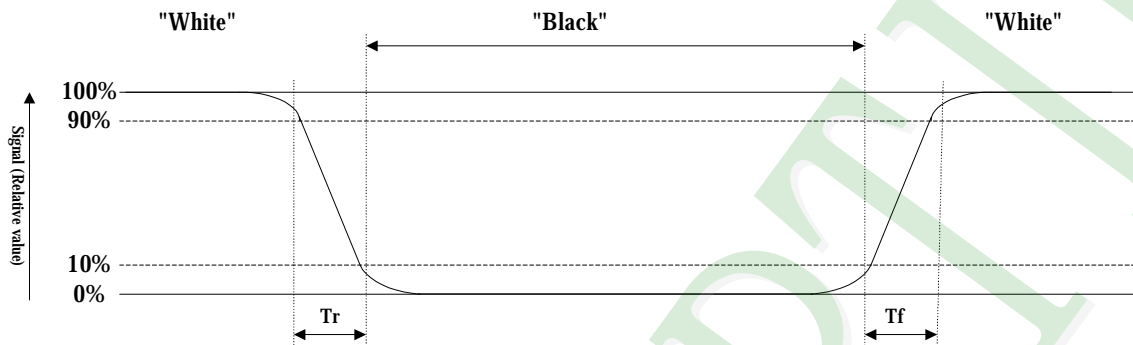
d : The uncertainty of the C.I.E coordinate measurement ±0.01 , Average Brightness ± 4%



Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from “black” to “white”(falling time) and from “white” to “black”(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



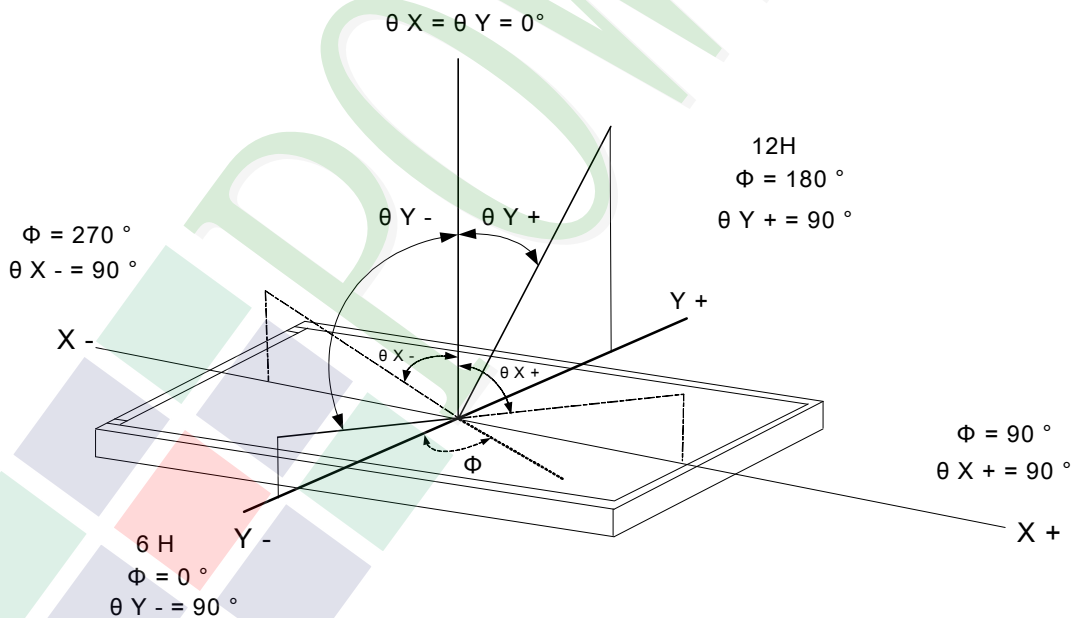
Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

$$\text{Contrast ratio (CR)} = \frac{\text{Photo detector output when LCD is at "White" state}}{\text{Photo detector output when LCD is at "Black" state}}$$

Note4: Definition of viewing angle:

Refer to figure as below:



1.6 Backlight Characteristics

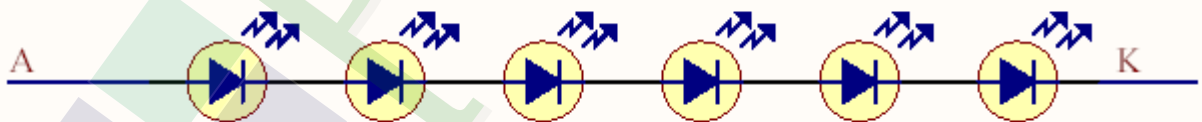
Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
LED Forward Current	If	Ta =25°C	-	30	mA
LED Reverse Voltage	Vr		-	5	V
Power Dissipation	Pd			540	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	VF	If=20mA	-	19.2	20.4	V
Average Brightness (Without LCD &T/P)	IV		4500	5200	-	cd/m ²
CIE Color Coordinate (Without LCD &T/P)	X		0.27	0.30	0.33	-
	Y		0.28	0.31	0.34	
Color	White					

Internal Circuit Diagram



Other Description

Item	Conditions	Description
Life Time	Ta =25°C IF= 20mA	20000 hrs

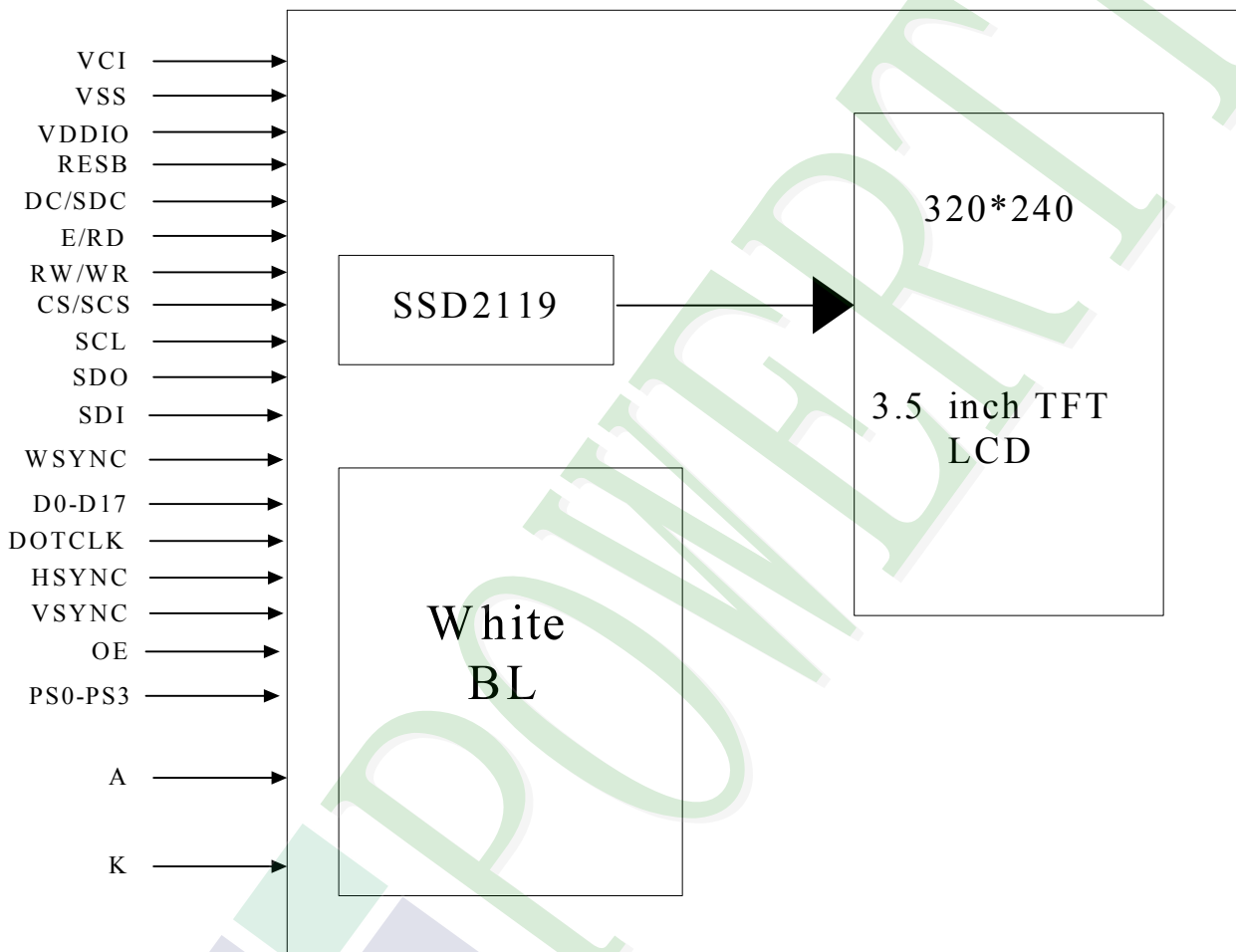
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

Pin No	Symbol	Function
1	VCI	Booster input voltage pin.
2	VCI	Booster input voltage pin.
3	VSS	System ground pin of the IC.
4.	VDDIO	Voltage input pin for logic I/O.
5	VSS	System ground pin of the IC.
6	RESB	System reset pin. - An active low pulse at this pin will reset the IC, Connect to VDDIO in normal operation.
7	DC/SDC	Data or command. DC: Parallel Interface. SDC: Serial Interface.
8	E/RD	6800-system:E(enable signal). 8080-system:RD(read strobe signal). Serial mode: Not used and should be connected to VDDIO or VSS.
9	RW/WR	6800-system: RW(indicates read cycle when High, write cycle when Low). 8080-system: WR(write strobe signal).
10	CS/SCS	CS: Chip Select pin for 6800/8080 Parallel Interface. SCS: Chip select pin for Serial Mode Interface.
11	SCL	Serial clock input.
12	SDO	Data output pin in serial interface.
13	SDI	Data input pin in serial interface.
14	WSYNC	Ram Write Synchronization output. -Leave it OPEN when not used.
15	D17	For parallel mode,8/9/16/18 bit interface. Unused pins should connect to VSS.
16	D16	
17	D15	
18	D14	
19	D13	



Pin No	Symbol	Function
20	D12	For parallel mode,8/9/16/18 bit interface. Unused pins should connect to VSS. Please refer to Table 1.
21	D11	
22	D10	
23	D9	
24	D8	
25	D7	
26	D6	
27	D5	
28	D4	
29	D3	
30	D2	
31	D1	
32	D0	
33	VSS	System ground pin of the IC.
34	DOTCLK	Dot-clock signal and oscillator source.
35	HSYNC	Line Synchronization input.
36	VSYNC	Frame/Ram Write Synchronization input.
37	OE	Display enable pin from controller.
38	VSS	System ground pin of the IC.
39	PS0	Please refer to Table 1.
40	PS1	
41	PS2	
42	PS3	
43	VSS	System ground pin for the IC.
44	NC	No connection, Must be open.
45	NC	No connection, Must be open.



Pin No	Symbol	Function
46	NC	No connection, Must be open.
47	NC	No connection, Must be open.
48	VSS	System ground pin for the IC.
49	K	Backlight LED's cathode.
50	A	Backlight LED's anode.

Table 1

PS3	PS2	PS1	PS0	Interface Mode	Data bus input
0	0	0	0	16-bit 6800 parallel interface.	D[17:10],D[8:1]
0	0	0	1	8-bit 6800 parallel interface.	D[17:10]
0	0	1	0	16-bit 8080 parallel interface.	D[17:10],D[8:1]
0	0	1	1	8-bit 8080 parallel interface.	D[17:10]
0	1	0	0	9-bit generic D[17:9] (262k color) + 3-wire SPI If 65K color, D12 shorts to D17 internally.	-
0	1	0	1	16-bit generic (262k color)+ 3-wire SPI.	-
0	1	1	0	18-bit generic (262k color)+ 3-wire SPI.	-
0	1	1	1	6-bit generic D[17:12] (262k color) + 3-wire SPI.	-
1	0	0	0	18-bits 6800 parallel interface.	D[17:0]
1	0	0	1	9-bits 6800 parallel interface.	D[17:9]
1	0	1	0	18-bit 8080 parallel interface.	D[17:0]
1	0	1	1	9-bit 8080 parallel interface.	D[17:9]
1	1	1	0	3-wire SPI.	-
1	1	1	1	4-wire SPI.	-

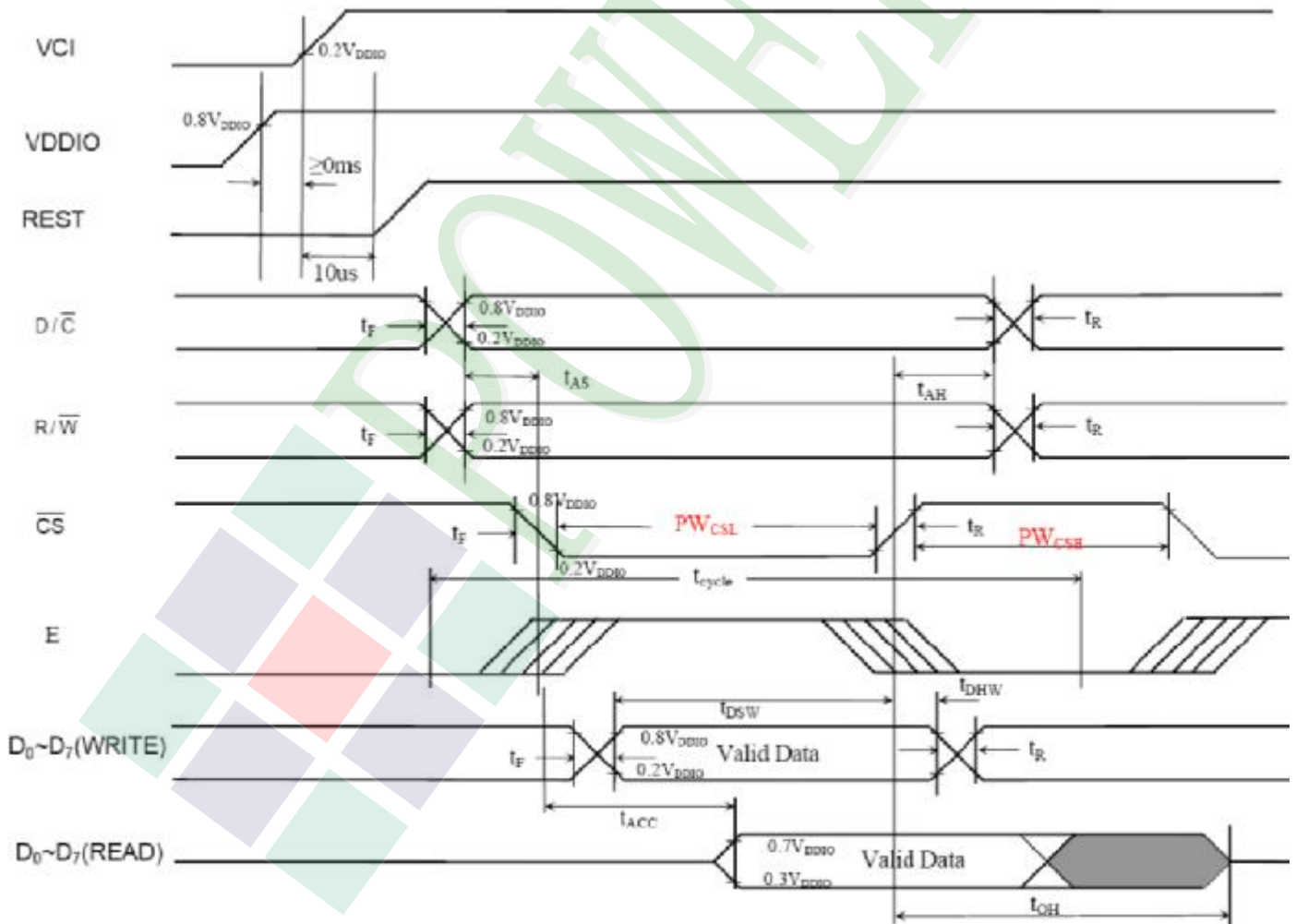


2.3 Timing Characteristics

2.3.1 6800 Interface Timing

Ta = -20 to 70 °C , VDDIO = 3.0 to 3.6V

Symbol	Parameter	Min	Typ	Max	Unit
t _{cycle}	Clock Cycle Time (write cycle)	75	-	-	ns
t _{cycle}	Clock Cycle Time (read cycle) (Based on VOL/VOH = 0.3*VDDIO/0.7*VDDIO)	450	-	-	ns
t _{AS}	Address Setup Time (R/W)	0	-	-	ns
t _{AH}	Address Hold Time (R/W)	0	-	-	ns
t _{DSW}	Data Setup Time (D0~D7, WRITE)	5	-	-	ns
t _{DHW}	Data Hold Time (D0~D7, WRITE)	5	-	-	ns
t _{ACC}	Data Access Time (D0~D7, READ)	200	-	-	ns
t _{OH}	Output Hold time (D0~D7, READ)	100	-	-	ns
PW _{CSL}	Pulse width /CS low (write cycle)	40	-	-	ns
PW _{CSH}	Pulse width /CS high (write cycle)	25	-	-	ns
PW _{CSL}	Pulse width /CS low (read cycle)	225	-	-	ns
PW _{CSH}	Pulse width /CS high (read cycle)	225	-	-	ns
t _R	Rise time	-	-	15	ns
t _F	Fall time	-	-	15	ns

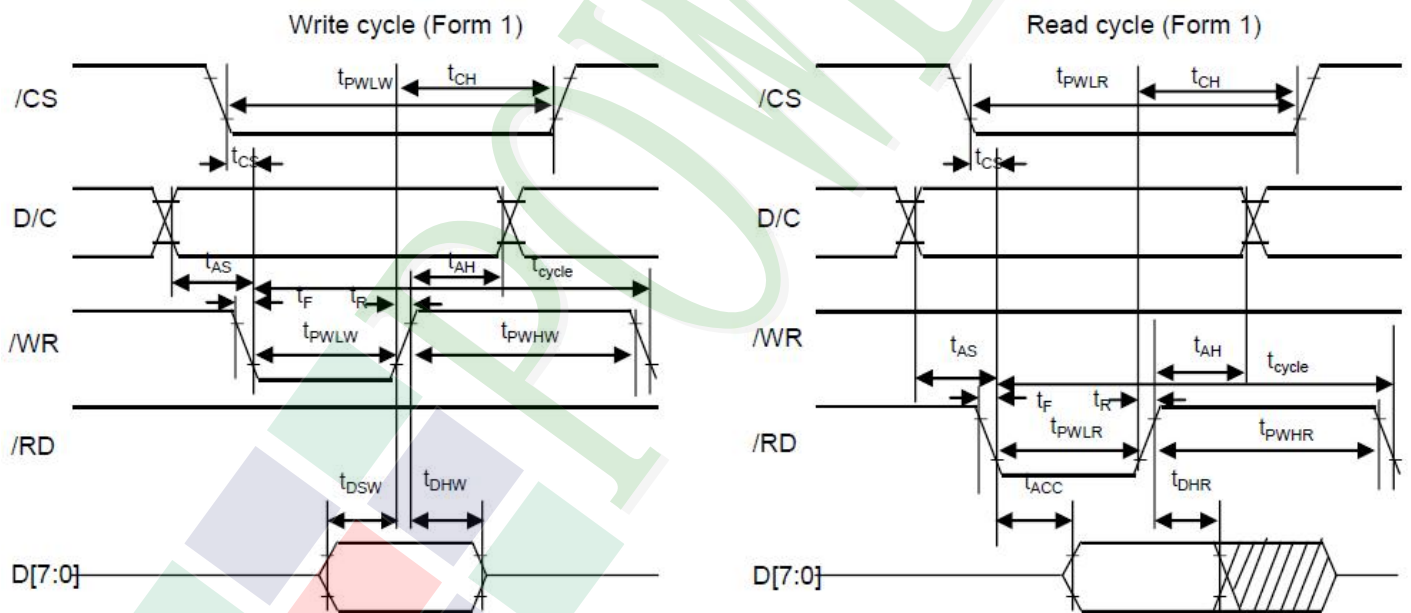


2.3.2 8080 Interface Timing

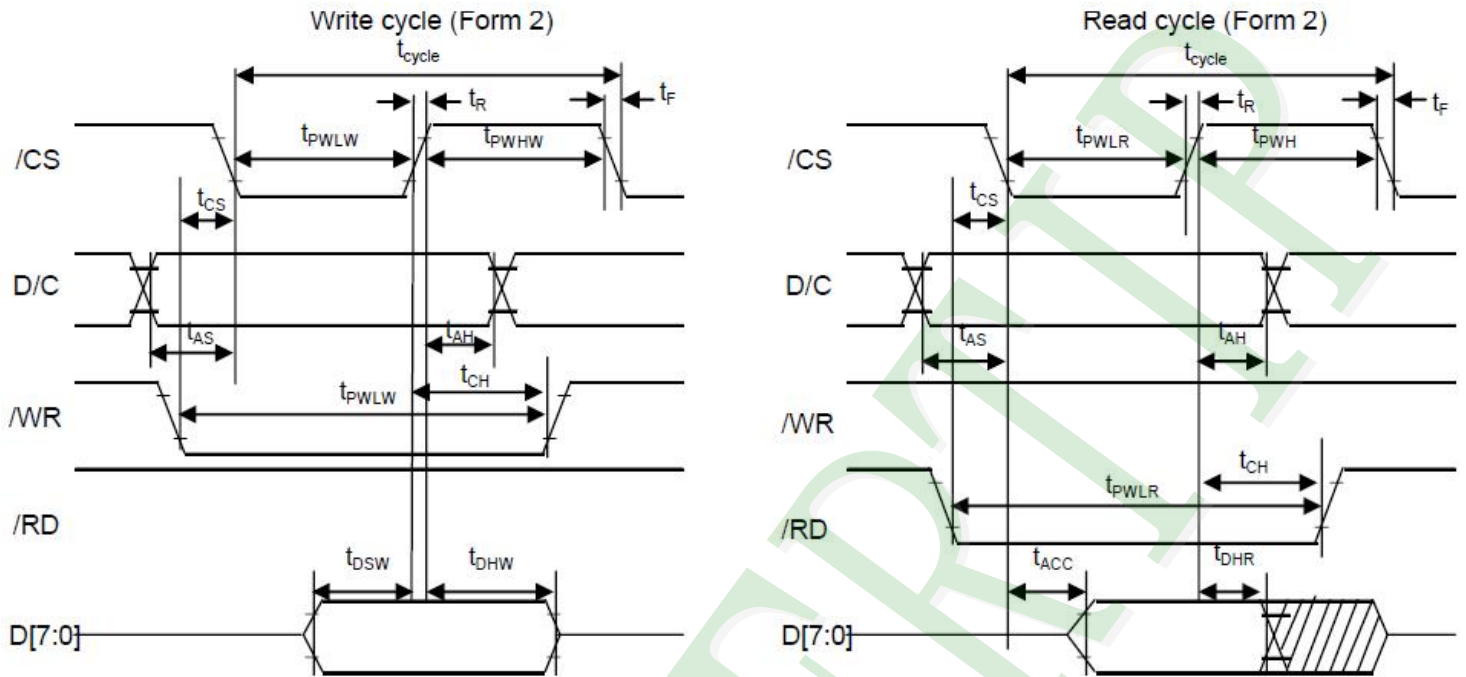
Symbol	Parameter	Min	Typ	Max	Unit
t_{cycle}	Clock Cycle Time (write cycle)	100	-	-	ns
t_{AS}	Address Setup Time	10	-	-	ns
t_{AH}	Address Hold Time	0	-	-	ns
t_{CS}	Chip Select Time	0	-	-	ns
t_{CH}	Chip Select Hold Time	0	-	-	ns
t_{DSW}	Write Data Setup Time	10	-	-	ns
t_{DHW}	Write Data Hold Time	10	-	-	ns
t_{DHR}	Read Data Hold Time	100	-	-	ns
t_{ACC}	Access Time (RAM)	250	-	-	ns
	Access Time (command)	250	-	-	ns
t_{PWLR}	Chip Select Low Pulse Width (read RAM)	500	-	-	ns
t_{PWLR}	Chip Select Low Pulse Width (read Command)	500	-	-	ns
t_{PWLW}	Chip Select Low Pulse Width (write)	50	-	-	ns
t_{PWHR}	Chip Select High Pulse Width (read)	500	-	-	ns
t_{PWHW}	Chip Select High Pulse Width (write)	50	-	-	ns
t_R	Rise Time	-	-	15	ns
t_F	Fall Time	-	-	15	ns

Note: All timings are based on 20% to 80% of VDDIO-VSS

Form 1: /CS low pulse width > /WR low pulse width



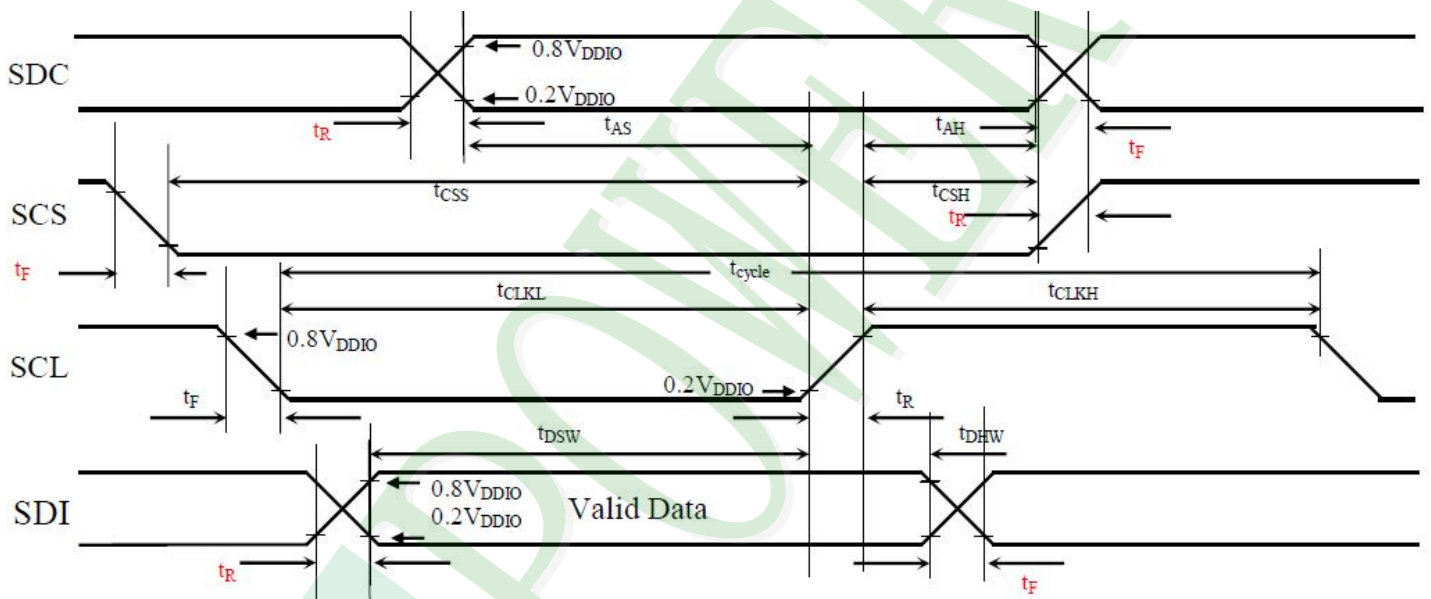
Form 2: /CS low pulse width < /WR low pulse width



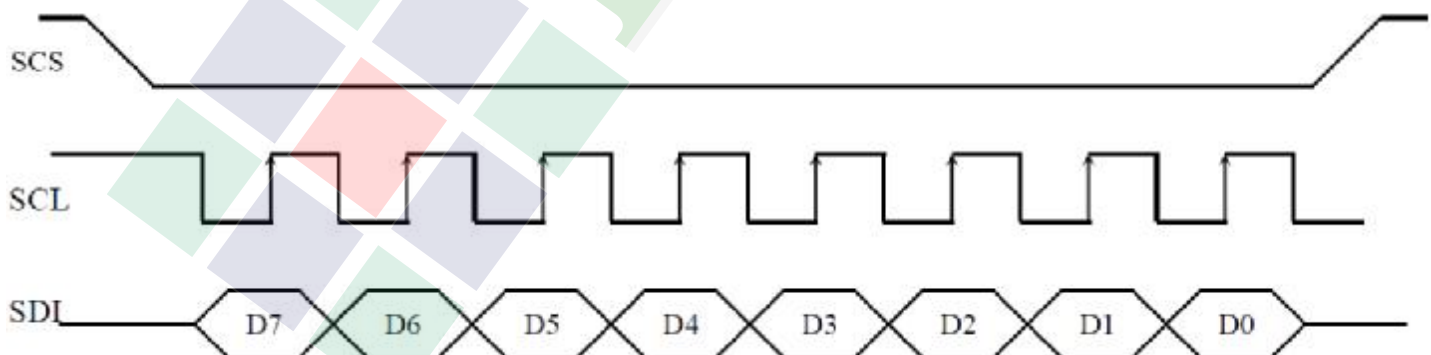
2.3.3 Serial Interface Timing

Ta= -20 to 70 °C , VDDIO = 3.0 to 3.6V

Symbol	Parameter	Min	Typ	Max	Unit
t _{cycle}	Clock Cycle Time	77	-	-	ns
f _{CLK}	Serial Clock Cycle Time SPI Clock tolerance = +/- 2 ppm	-	-	15	MHz
t _{AS}	Register select Setup Time	4	-	-	ns
t _{AH}	Register select Hold Time	5	-	-	ns
t _{CSS}	Chip Select Setup Time	2	-	-	ns
t _{CSH}	Chip Select Hold Time	10	-	-	ns
t _{DSW}	Write Data Setup Time	5	-	-	ns
t _{OHW}	Write Data Hold Time	10	-	-	ns
t _{CLKL}	Clock Low Time	38	-	-	ns
t _{CLKH}	Clock High Time	38	-	-	ns
t _R	Rise time	-	-	15	ns
t _F	Fall time	-	-	15	ns



Data format



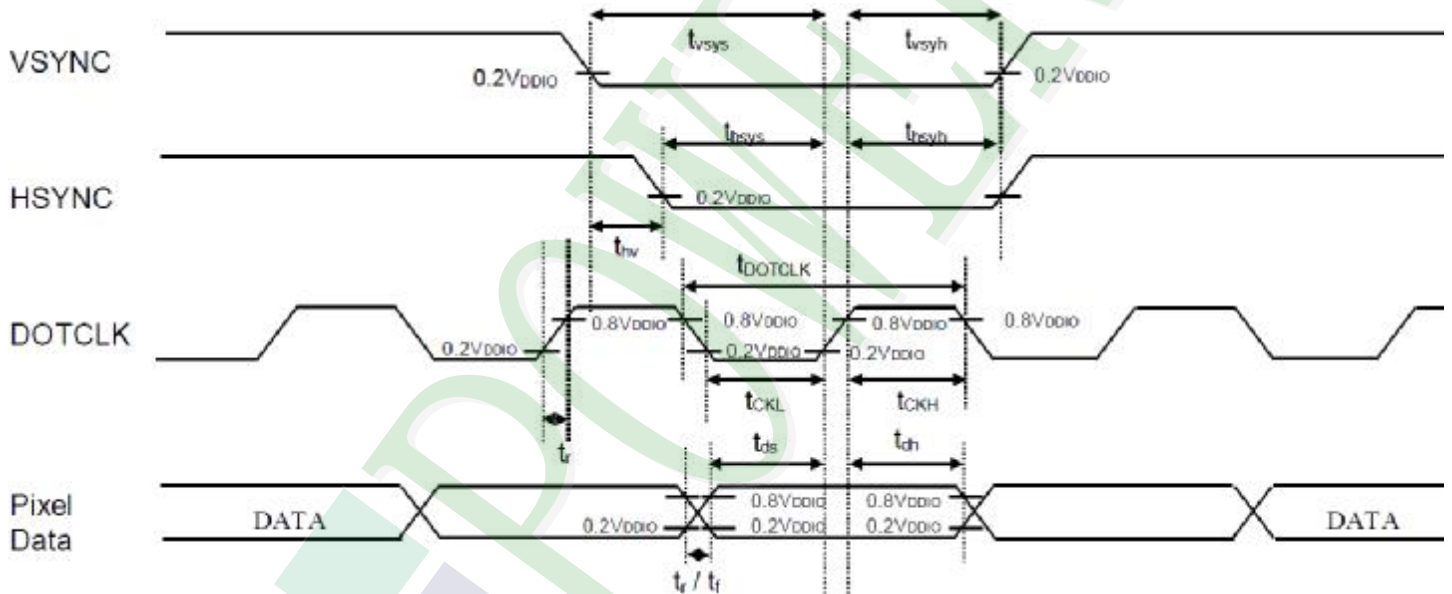
2.3.4 RGB Interface Timing

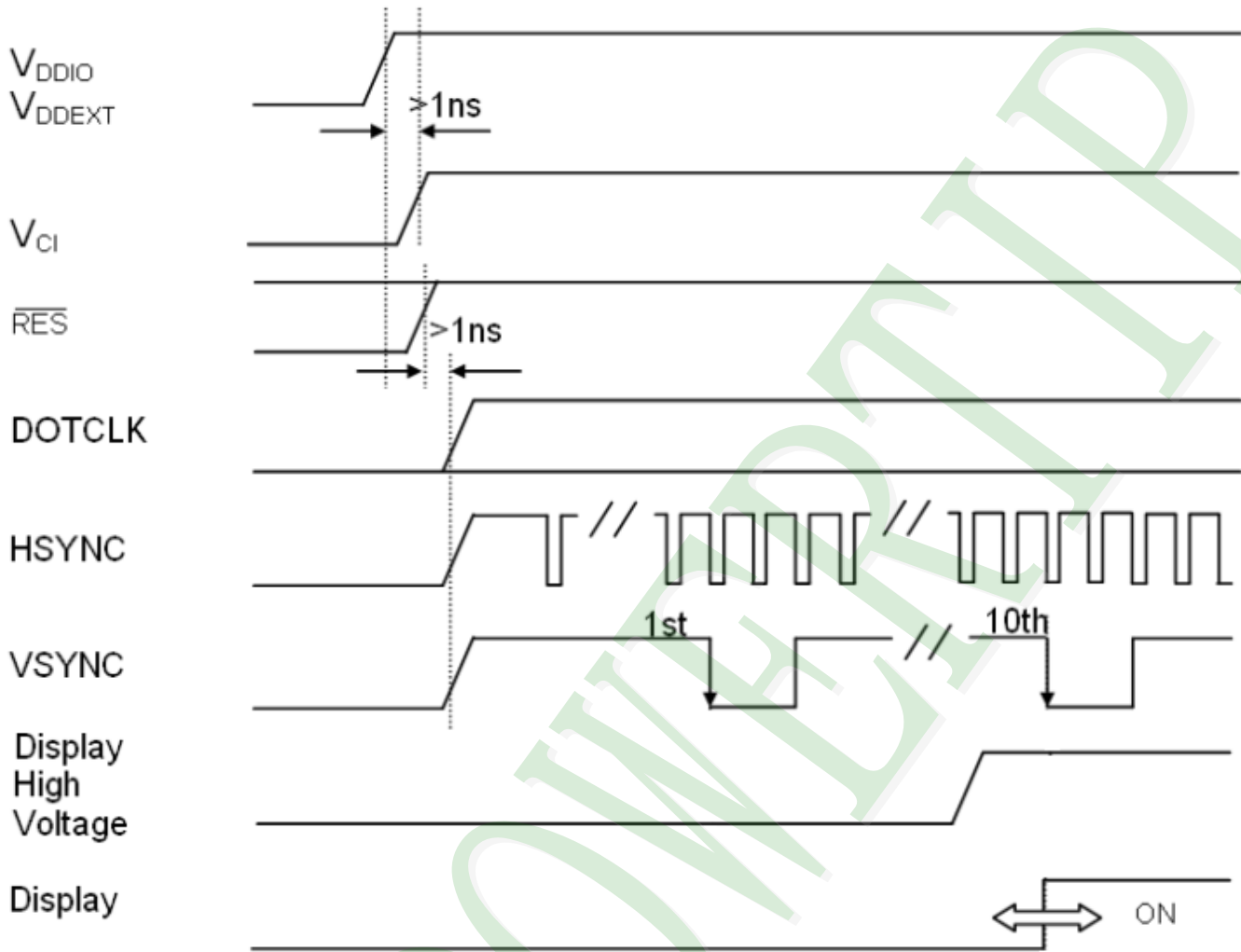
Ta= -20 to 70 °C , VDDIO = 3.0 to 3.6V

Symbol	Parameter	Min	Typ	Max	Unit
f _{DOTCLK}	DOTCLK Frequency (70Hz frame rate)	1	5.5	8.2	MHz
t _{DOTCLK}	DOTCLK Period	122	182	1000	ns
t _{VSYS}	Vertical Sync Setup Time	20	-	-	ns
t _{VSyh}	Vertical Sync Hold Time	20	-	-	ns
t _{HSYS}	Horizontal Sync Setup Time	20	-	-	ns
t _{HSyh}	Horizontal Sync Hold Time	20	-	-	ns
t _{HV}	Phase difference of Sync Signal Falling Edge	0	-	HFP-1	t _{DOTCLK}
t _{CLK}	DOTCLK Low Period	61	-	-	ns
t _{CKH}	DOTCLK High Period	61	-	-	ns
t _{DS}	Data Setup Time	25	-	-	ns
t _{DH}	Data hold Time	25	-	-	ns

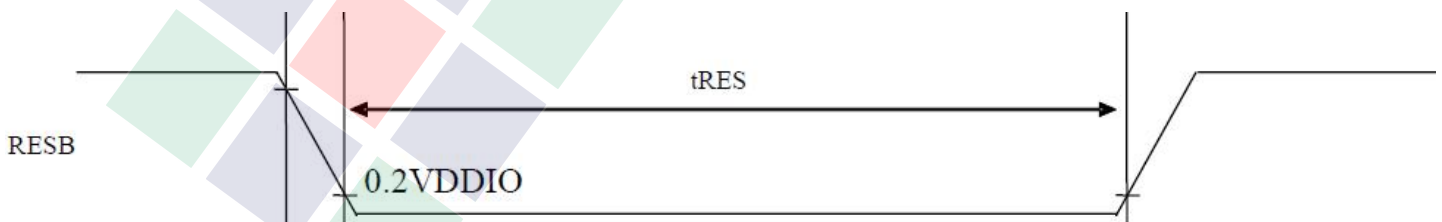
Note: External clock source must be provided to DOTCLK pin of SSD2119AM1. The driver will not operate in absence of the clocking signal.

*HFP: Horizontal Front Porch setting in customers' setup



Power Up Sequence for RGB mode

2.3.5 Reset Timing
 $T_a = -20 \text{ to } 70 \text{ } ^\circ\text{C}$, $V_{DDIO} = 3.0 \text{ to } 3.6\text{V}$

Symbol	Parameter	Min	Typ	Max	Unit
t_{RES}	Reset pulse duration	15	-	-	μs





2.4 Programming Init code

;For SSD2119---16-bit 8080-series Parallel Interface.

INIT_MAIN

```

MOV    ADDRH,#00H
MOV    ADDR, #28H
CALL   WRITE_COMMAND
MOV    ADDRH,#00H
MOV    ADDR, #06H
CALL   WRITE_DATA

```

```

MOV    ADDRH,#00H
MOV    ADDR, #00H
CALL   WRITE_COMMAND
MOV    ADDRH,#00H
MOV    ADDR, #01H
CALL   WRITE_DATA

```

```

MOV    ADDRH,#00H
MOV    ADDR, #01H
CALL   WRITE_COMMAND
MOV    ADDRH,#00111010b
MOV    ADDR, #efH;EFH
CALL   WRITE_DATA

```

```

MOV    ADDRH,#00H
MOV    ADDR, #02H
CALL   WRITE_COMMAND
MOV    ADDRH,#06H
MOV    ADDR, #00H
CALL   WRITE_DATA

```

```

MOV    ADDRH,#00H
MOV    ADDR, #03H ;VGH/VGL Voltage Setting
CALL   WRITE_COMMAND
MOV    ADDRH,#64H
MOV    ADDR, #64H
CALL   WRITE_DATA

```

```

MOV    ADDRH,#00H
MOV    ADDR, #10H
CALL   WRITE_COMMAND
MOV    ADDRH,#00H
MOV    ADDR, #00H
CALL   WRITE_DATA

```

```

MOV    ADDRH,#00H
MOV    ADDR, #11H
CALL   WRITE_COMMAND
MOV    ADDRH,#64H
MOV    ADDR, #30H

```



```
CALL WRITE_DATA
CALL DELAY
CALL DELAY

MOV ADDRH,#00H
MOV ADDRL,#07H
CALL WRITE_COMMAND
MOV ADDRH,#00H
MOV ADDRL,#33H
CALL WRITE_DATA
CALL DELAY

MOV ADDRH,#00H
MOV ADDRL,#25H
CALL WRITE_COMMAND
MOV ADDRH,#e0H
MOV ADDRL,#00H
CALL WRITE_DATA

MOV ADDRH,#00H
MOV ADDRL,#0bH
CALL WRITE_COMMAND
MOV ADDRH,#53H
MOV ADDRL,#08H
CALL WRITE_DATA
```

;----- Adjust the Gamma Curve -----;

```
MOV ADDRH,#00H
MOV ADDRL,#30H
CALL WRITE_COMMAND
MOV ADDRH,#BFH
MOV ADDRL,#BDH
CALL WRITE_DATA

MOV ADDRH,#00H
MOV ADDRL,#31H
CALL WRITE_COMMAND
MOV ADDRH,#52H
MOV ADDRL,#47H
CALL WRITE_DATA

MOV ADDRH,#00H
MOV ADDRL,#32H
CALL WRITE_COMMAND
MOV ADDRH,#DDH
MOV ADDRL,#BAH
CALL WRITE_DATA

MOV ADDRH,#00H
MOV ADDRL,#33H
CALL WRITE_COMMAND
```



POWER TIP

```
MOV    ADDRH,#35H
MOV    ADDRL,#0EH
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#34H
CALL   WRITE_COMMAND
MOV    ADDRH,#A6H
MOV    ADDRL,#BFH
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#35H
CALL   WRITE_COMMAND
MOV    ADDRH,#39H
MOV    ADDRL,#BCH
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#36H
CALL   WRITE_COMMAND
MOV    ADDRH,#C5H
MOV    ADDRL,#20H
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#37H
CALL   WRITE_COMMAND
MOV    ADDRH,#34H
MOV    ADDRL,#1EH
CALL   WRITE_DATA
```

;-----power on sequence-----

```
MOV    ADDRH,#00H
MOV    ADDRL,#0CH
CALL   WRITE_COMMAND
MOV    ADDRH,#00H
MOV    ADDRL,#05H
CALL   WRITE_DATA
CALL   DELAY
CALL   DELAY
CALL   DELAY
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#0dH
CALL   WRITE_COMMAND
MOV    ADDRH,#00H
MOV    ADDRL,#12H
CALL   WRITE_DATA
CALL   DELAY
```



POWERTIP

```
CALL    DELAY
CALL    DELAY

MOV     ADDRH,#00H
MOV     ADDRL,#1eH      ;VCOMH setup
CALL    WRITE_COMMAND
MOV     ADDRH,#00H
MOV     ADDRL,#E6H
CALL    WRITE_DATA
CALL    DELAY

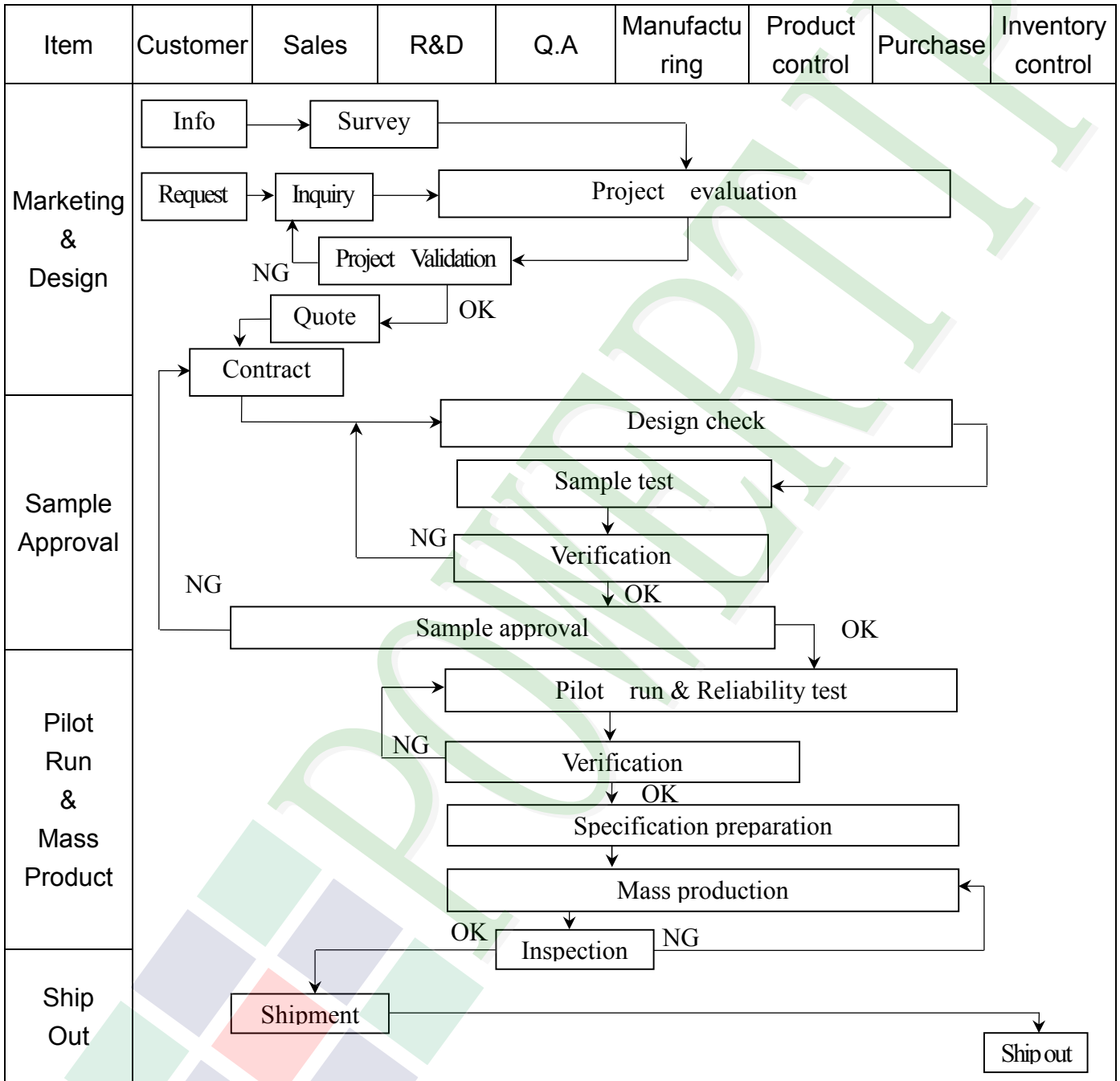
MOV     ADDRH,#00H
MOV     ADDRL,#0eH      ;VCOML setup
CALL    WRITE_COMMAND
MOV     ADDRH,#29H
MOV     ADDRL,#00H
CALL    WRITE_DATA
CALL    DELAY

MOV     ADDRH,#00H
MOV     ADDRL,#26H
CALL    WRITE_COMMAND
MOV     ADDRH,#7cH
MOV     ADDRL,#00H
CALL    WRITE_DATA

MOV     ADDRH,#00H
MOV     ADDRL,#27H
CALL    WRITE_COMMAND
MOV     ADDRH,#00H
MOV     ADDRL,#6dH
CALL    WRITE_DATA
```


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart





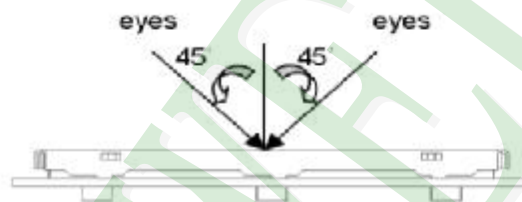
Item	Customer	Sales	R&D	Q.A	Manufacturing	Product control	Purchase	Inventory control
Sales Service	<pre> graph TD Info[Info] --> Claim[Claim] Claim --> FA[Failure analysis] Claim --> AR[Analysis report] FA --> CA[Corrective action] CA --> Tracking[Tracking] </pre>							
Q.A Activity	1. ISO 9001 Maintenance Activities 3. Equipment calibration 5. Standardization Management				2. Process improvement proposal 4. Education And Training Activities			

3.2. Inspection Specification

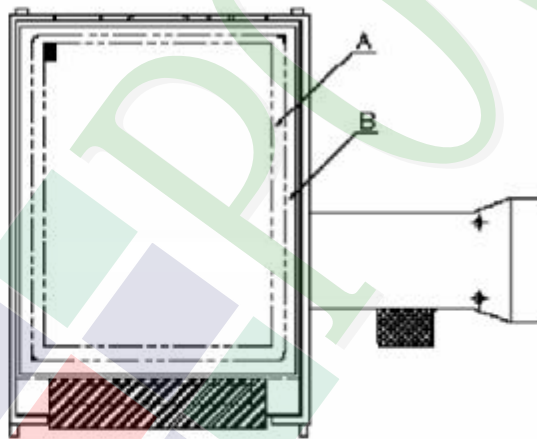
- ◆ Scope : The document shall be applied to TFT-LCD Module for 3.5" ~10" (Ver.B01).
- ◆ Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level II .
- ◆ Equipment : Gauge 、 MIL-STD 、 Powertip Tester 、 Sample
- ◆ Defect Level : Major Defect AQL : 0.4 ; Minor Defect AQL : 1.5
- ◆ OUT Going Defect Level : Sampling.
- ◆ Standard of the product appearance test :

a. Manner of appearance test :

- (1). The test best be under 20W×2 fluorescent light , and distance of view must be at 30 cm.
- (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area : viewing area

B area : Outside of viewing area

(4). Standard of inspection : (Unit : mm)



◆ Specification For TFT-LCD Module 3.5" ~10" :

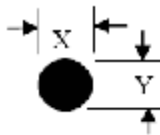
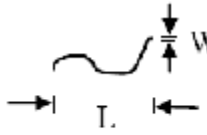
(Ver.B01)

NO	Item	Criterion	Level										
01	Product condition	1. 1 The part number is inconsistent with work order of production.	Major										
		1. 2 Mixed product types.	Major										
		1. 3 Assembled in inverse direction.	Major										
02	Quantity	2. 1 The quantity is inconsistent with work order of production.	Major										
03	Outline dimension	3. 1 Product dimension and structure must conform to structure diagram.	Major										
		4. 1 Missing line character and icon.	Major										
04	Electrical Testing	4. 2 No function or no display.	Major										
		4. 3 Display malfunction.	Major										
		4. 4 LCD viewing angle defect.	Major										
		4. 5 Current consumption exceeds product specifications.	Major										
05	Dot defect (Bright dot , Dark dot) On -display	<table border="1"> <thead> <tr> <th>Item</th> <th>Acceptance (Q'ty)</th> </tr> </thead> <tbody> <tr> <td>Bright Dot</td> <td>≤ 4</td> </tr> <tr> <td>Dark Dot</td> <td>≤ 5</td> </tr> <tr> <td>Joint Dot</td> <td>≤ 3</td> </tr> <tr> <td>Total</td> <td>≤ 7</td> </tr> </tbody> </table>	Item	Acceptance (Q'ty)	Bright Dot	≤ 4	Dark Dot	≤ 5	Joint Dot	≤ 3	Total	≤ 7	Minor
		Item	Acceptance (Q'ty)										
		Bright Dot	≤ 4										
		Dark Dot	≤ 5										
		Joint Dot	≤ 3										
Total	≤ 7												
5. 1 Inspection pattern : full white , full black , Red , Green and blue screens.													
5. 2 It is defined as dot defect if defect area $> 1/2$ dot.													
5. 3 The distance between two dot defect ≥ 5 mm.													



◆ Specification For TFT-LCD Module 3.5" ~10" :

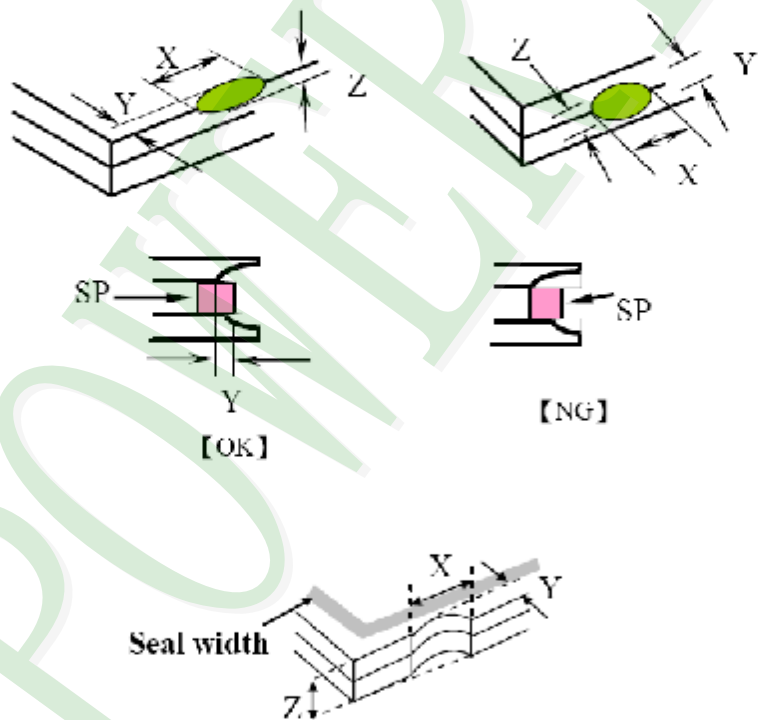
(Ver.B01)

NO	Item	Level																																									
06	<p style="text-align: center;">6.1 Round type (Non-display or display) :</p> <div style="display: flex; justify-content: space-between;"> <div style="width: 45%;"> <p>Black or white dot、scratch、contamination</p> <p>Round type</p>  <p>$\Phi = (x + y) / 2$</p> <p>Line type</p>  </div> <div style="width: 50%;"> <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th rowspan="2">Dimension (diameter : Φ)</th> <th colspan="2">Acceptance (Q'ty)</th> </tr> <tr> <th>A area</th> <th>B area</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">$\Phi \leq 0.25$</td> <td colspan="2" style="text-align: center;">Ignore</td> </tr> <tr> <td style="text-align: center;">$0.25 < \Phi \leq 0.50$</td> <td style="text-align: center;">5</td> <td rowspan="2" style="text-align: center;">Ignore</td> </tr> <tr> <td style="text-align: center;">$\Phi > 0.50$</td> <td style="text-align: center;">0</td> </tr> <tr> <td style="text-align: center;">Total</td> <td style="text-align: center;">5</td> <td></td> </tr> </tbody> </table> <p style="text-align: center;">6.2 Line type(Non-display or display) :</p> <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th rowspan="2">Length (L)</th> <th rowspan="2">Width (W)</th> <th colspan="2">Acceptance (Q'ty)</th> </tr> <tr> <th>A area</th> <th>B area</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">---</td> <td style="text-align: center;">$W \leq 0.03$</td> <td colspan="2" style="text-align: center;">Ignore</td> </tr> <tr> <td style="text-align: center;">$L \leq 10.0$</td> <td style="text-align: center;">$0.03 < W \leq 0.05$</td> <td style="text-align: center;">4</td> <td rowspan="2" style="text-align: center;">Ignore</td> </tr> <tr> <td style="text-align: center;">$L \leq 5.0$</td> <td style="text-align: center;">$0.05 < W \leq 0.10$</td> <td style="text-align: center;">2</td> </tr> <tr> <td style="text-align: center;">---</td> <td style="text-align: center;">$W > 0.10$</td> <td colspan="2" style="text-align: center;">As round type</td> </tr> <tr> <td colspan="2" style="text-align: center;">Total</td> <td colspan="2" style="text-align: center;">5</td> </tr> </tbody> </table> </div> </div>	Dimension (diameter : Φ)	Acceptance (Q'ty)		A area	B area	$\Phi \leq 0.25$	Ignore		$0.25 < \Phi \leq 0.50$	5	Ignore	$\Phi > 0.50$	0	Total	5		Length (L)	Width (W)	Acceptance (Q'ty)		A area	B area	---	$W \leq 0.03$	Ignore		$L \leq 10.0$	$0.03 < W \leq 0.05$	4	Ignore	$L \leq 5.0$	$0.05 < W \leq 0.10$	2	---	$W > 0.10$	As round type		Total		5		Minor
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07	<p>Polarizer Bubble</p> <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th rowspan="2">Dimension (diameter : Φ)</th> <th colspan="2">Acceptance (Q'ty)</th> </tr> <tr> <th>A area</th> <th>B area</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">$\Phi \leq 0.25$</td> <td colspan="2" style="text-align: center;">Ignore</td> </tr> <tr> <td style="text-align: center;">$0.25 < \Phi \leq 0.50$</td> <td style="text-align: center;">4</td> <td rowspan="2" style="text-align: center;">Ignore</td> </tr> <tr> <td style="text-align: center;">$0.50 < \Phi \leq 0.80$</td> <td style="text-align: center;">1</td> </tr> <tr> <td style="text-align: center;">$\Phi > 0.80$</td> <td style="text-align: center;">0</td> <td></td> </tr> <tr> <td style="text-align: center;">Total</td> <td style="text-align: center;">5</td> <td></td> </tr> </tbody> </table>	Dimension (diameter : Φ)	Acceptance (Q'ty)		A area	B area	$\Phi \leq 0.25$	Ignore		$0.25 < \Phi \leq 0.50$	4	Ignore	$0.50 < \Phi \leq 0.80$	1	$\Phi > 0.80$	0		Total	5		Minor																						
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$\Phi > 0.80$	0																																										
Total	5																																										



◆ Specification For TFT-LCD Module 3.5" ~10" :

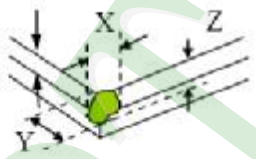
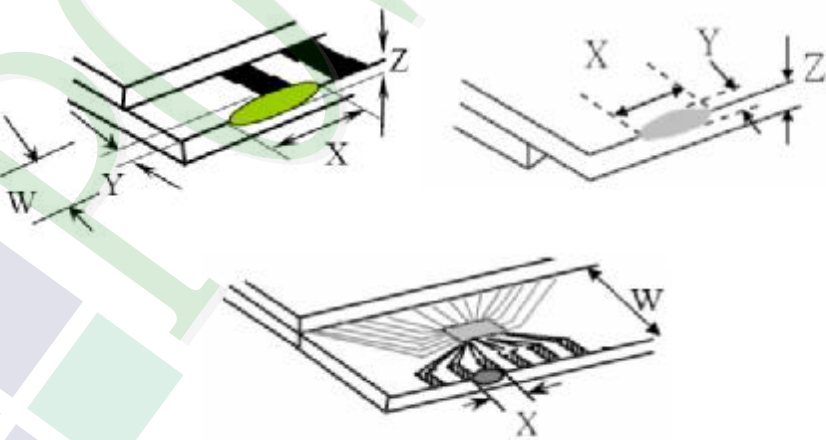
(Ver.B01)

NO	Item	Criterion	Level						
08	The crack of glass	<p>Symbols :</p> <p>X : The length of crack Z : The thickness of crack t : The thickness of glass</p> <p>Y : The width of crack. W : terminal length a : LCD side length</p>	Minor						
		<p>8.1 General glass chip :</p> <p>8.1.1 Chip on panel surface and crack between panels:</p>  <p>Seal width</p> <table border="1" data-bbox="542 1590 1340 1904"> <tr> <td>X</td> <td>Y</td> <td>Z</td> </tr> <tr> <td>$\leq a$</td> <td>Crack can't enter viewing area</td> <td>$\leq 1/2 t$</td> </tr> <tr> <td>$\leq a$</td> <td>Crack can't exceed the half of SP width.</td> <td>$1/2 t < Z \leq 2 t$</td> </tr> </table>		X	Y	Z	$\leq a$	Crack can't enter viewing area	$\leq 1/2 t$
X	Y	Z							
$\leq a$	Crack can't enter viewing area	$\leq 1/2 t$							
$\leq a$	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$							



◆ Specification For TFT-LCD Module 3.5" ~10" :

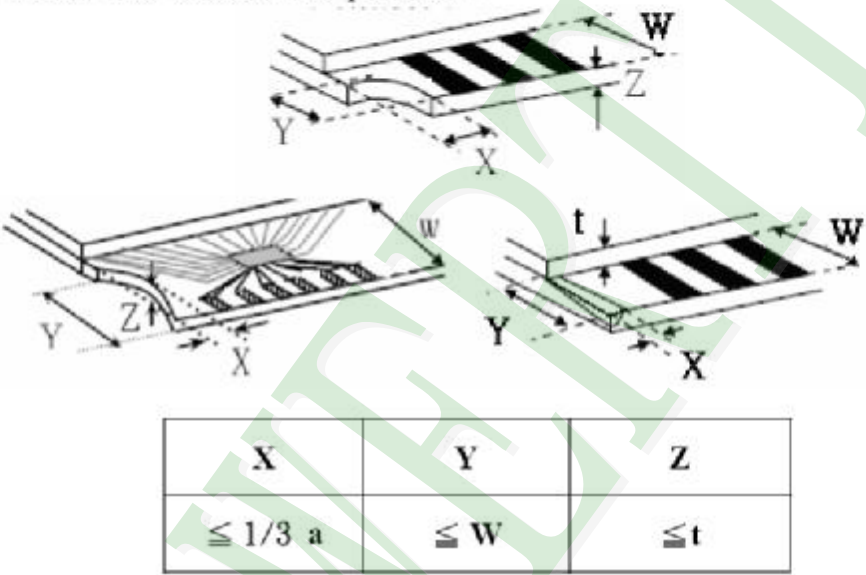
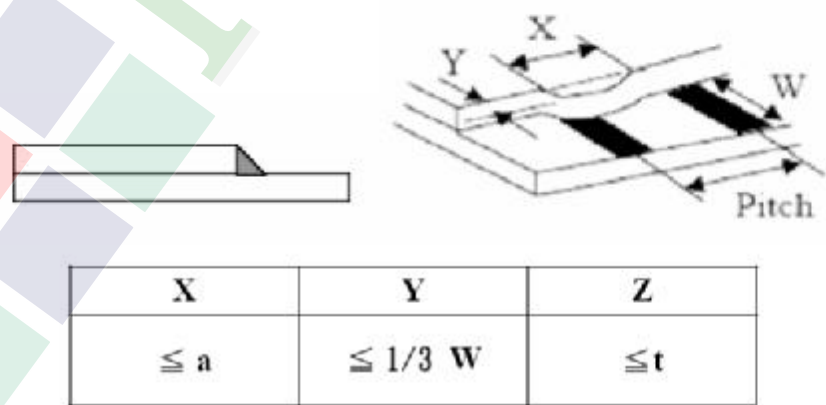
(Ver.B01)

NO	Item	Criterion	Level												
08	The crack of glass	<p>Symbols :</p> <p>X : The length of crack Z : The thickness of crack t : The thickness of glass</p> <p>Y : The width of crack. W : terminal length a : LCD side length</p> <hr/> <p>8.1.2 Corner crack :</p>  <table border="1" data-bbox="523 810 1332 1102"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>$\leq 1/5 a$</td> <td>Crack can't enter viewing area</td> <td>$Z \leq 1/2 t$</td> </tr> <tr> <td>$\leq 1/5 a$</td> <td>Crack can't exceed the half of SP width.</td> <td>$1/2 t < Z \leq 2 t$</td> </tr> </tbody> </table>	X	Y	Z	$\leq 1/5 a$	Crack can't enter viewing area	$Z \leq 1/2 t$	$\leq 1/5 a$	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$				
		X	Y	Z											
$\leq 1/5 a$	Crack can't enter viewing area	$Z \leq 1/2 t$													
$\leq 1/5 a$	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$													
		<p>8.2 Protrusion over terminal :</p> <p>8.2.1 Chip on electrode pad :</p>  <table border="1" data-bbox="561 1729 1343 1904"> <thead> <tr> <th></th> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>Front</td> <td>$\leq a$</td> <td>$\leq 1/2 W$</td> <td>$\leq t$</td> </tr> <tr> <td>Back</td> <td>$\leq a$</td> <td>$\leq W$</td> <td>$\leq 1/2 t$</td> </tr> </tbody> </table>		X	Y	Z	Front	$\leq a$	$\leq 1/2 W$	$\leq t$	Back	$\leq a$	$\leq W$	$\leq 1/2 t$	Minor
	X	Y	Z												
Front	$\leq a$	$\leq 1/2 W$	$\leq t$												
Back	$\leq a$	$\leq W$	$\leq 1/2 t$												



◆ Specification For TFT-LCD Module 3.5" -10" :

(Ver.B01)

NO	Item	Criterion	Level
08	The crack of glass	<p>Symbols :</p> <p>X : The length of crack Y : The width of crack. Z : The thickness of crack W : terminal length t : The thickness of glass a : LCD side length</p>	Minor
		<p>8.2.2 Non-conductive portion :</p>  <p>⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.</p> <p>8.2.3 Glass remain :</p> 	

4. RELIABILITY TEST
4.1 Reliability Test Condition
(VER.B01)

NO.	TEST ITEM	TEST CONDITION										
1	High Temperature Storage Test	Keep in 80°C ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.										
2	Low Temperature Storage Test	Keep in -30°C ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.										
3	High Temperature / High Humidity Storage Test	Keep in +60 °C / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)										
4	Temperature Cycling Storage Test	$-30^{\circ}\text{C} \rightarrow +25^{\circ}\text{C} \rightarrow +80^{\circ}\text{C} \rightarrow +25^{\circ}\text{C}$ $\xleftarrow{(30\text{mins})} \quad \xrightarrow{(5\text{mins})} \quad \xrightarrow{(30\text{mins})} \quad \xrightarrow{(5\text{mins})}$ <p>10 Cycle</p> Surrounding temperature, then storage at normal condition 4hrs.										
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-										
		Contact Discharge: Apply 250 V with 5 times discharge for each polarity +/-										
		1. Temperature ambience : 15°C ~35°C 2. Humidity relative : 30%~60% 3. Energy Storage Capacitance(Cs+Cd) : 150pF±10% 4. Discharge Resistance(Rd) : 330Ω±10% 5. Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication : ±5%)										
6	Vibration Test (Packaged)	1. Sine wave 10~55 Hz frequency (1 min/sweep) 2. The amplitude of vibration :1.5 mm 3. Each direction (X、Y、Z) duration for 2 Hrs										
7	Drop Test (Packaged)	<table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th>Packing Weight (Kg)</th> <th>Drop Height (cm)</th> </tr> </thead> <tbody> <tr> <td>0 ~ 45.4</td> <td>122</td> </tr> <tr> <td>45.4 ~ 90.8</td> <td>76</td> </tr> <tr> <td>90.8 ~ 454</td> <td>61</td> </tr> <tr> <td>Over 454</td> <td>46</td> </tr> </tbody> </table> Drop Direction :※1 corner / 3 edges / 6 sides each 1time.	Packing Weight (Kg)	Drop Height (cm)	0 ~ 45.4	122	45.4 ~ 90.8	76	90.8 ~ 454	61	Over 454	46
Packing Weight (Kg)	Drop Height (cm)											
0 ~ 45.4	122											
45.4 ~ 90.8	76											
90.8 ~ 454	61											
Over 454	46											



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

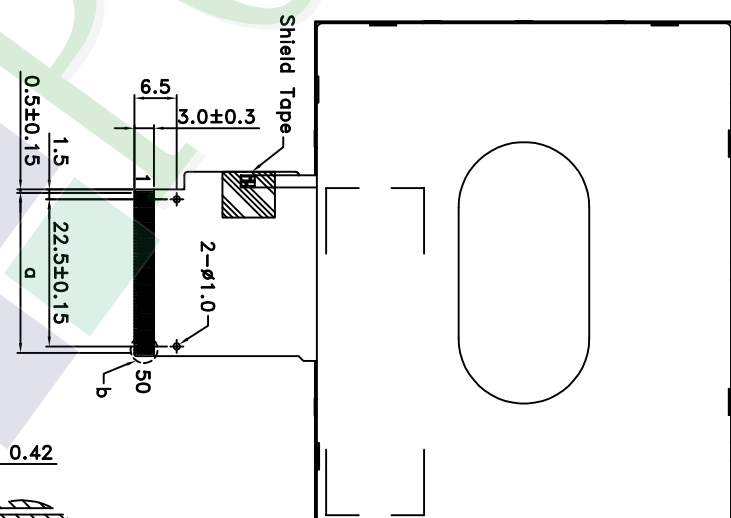
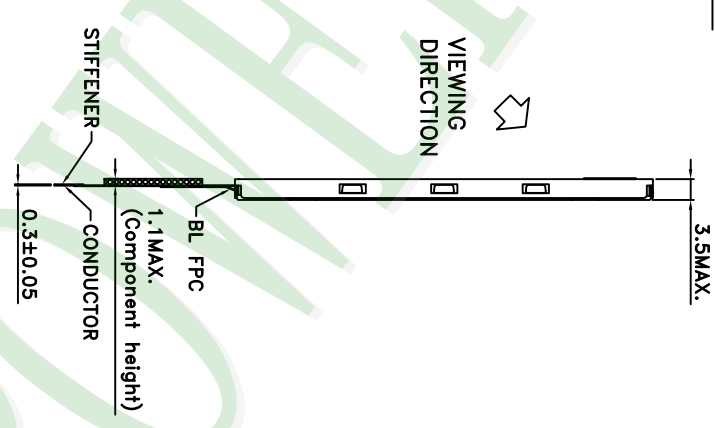
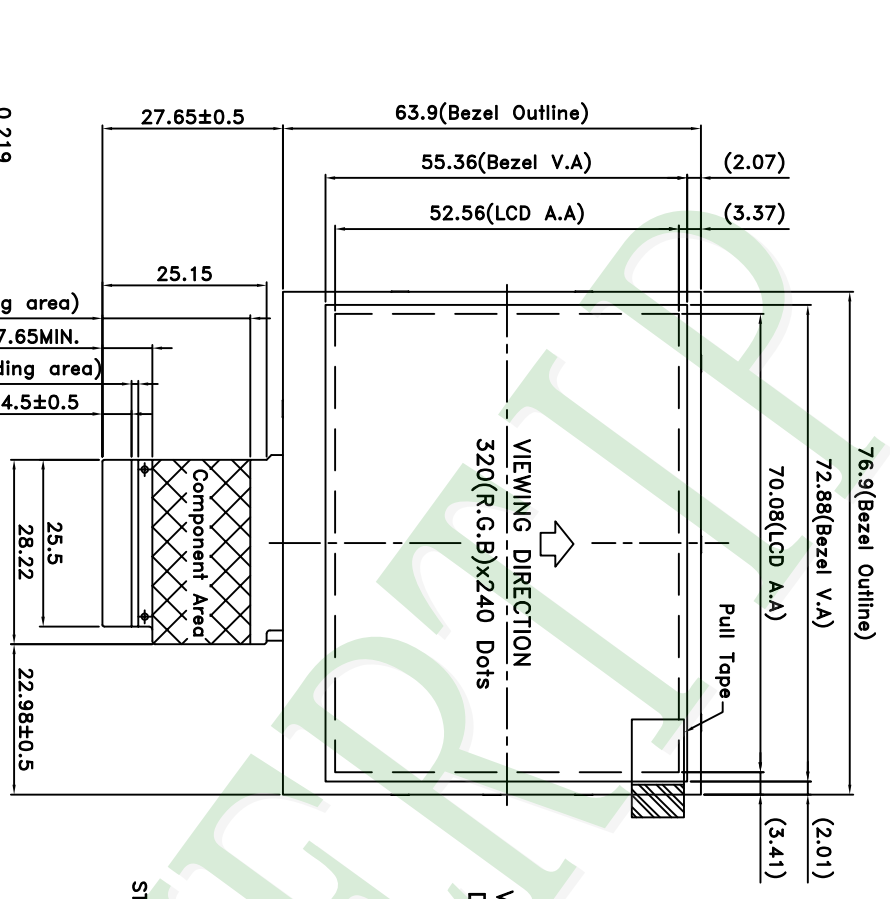
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully, do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320 \pm 10^{\circ}\text{C}$ and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

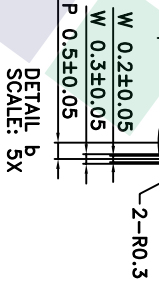
5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period
The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Detail DOTS
Scale: 50/1

NOTES:
 1.LCD TYPE: g-Si TFT
 2.LCD DISPLAY: POSITIVE/TRANSMISSIVE
 3.VIEW DIRECTION: 6 O'CLOCK
 4.The tolerance unless classified ±0.2mm
 5.a: PITCH 0.5X49=24.5±0.1
 6.FPC suggested connector: "Hirose" FH12S-50S-0.5SH(55) or compatible.



007																				
006																				
005																				
004																				
003																				
002	Add FPC suggested connector	Eva	2014/03/27																	
001	NEW DRAWING	Mag	2010/06/30																	
REV	REV BY	REVISER	DATE																	

PART NO:
PH320240T-022-1-Q

久正光電股份有限公司
POWER TIP TECHNOLOGY CORPORATION

DRAWING NAME:
LMD-PH320240T-022-1-Q

Design Eva Liao
Check Tina Chen

Surface Material
Unit MM
Scale FT
Page 1/1
Quantity

Approve	Check	Contact
Linda	Tina	Mag

Documents NO. PKG-PH320240T-022-I-Q

1. 包裝材料規格表 (Packaging Material) : (per carton)

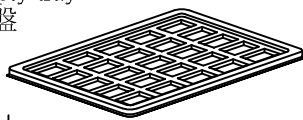
No.	Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (LCM)	PH320240T-022-I-Q	76.9 X 63.9	0.031	288	8.928
2	多層薄膜(1)POF	OTFILM0BA03ABA	19"X350X0.015	—	6	—
3	TRAY 盤 (2)Tray	TY32024001TZBA	352 X 260 X 10.8	0.0967	54	5.2218
4	內盒(3)Product Box	BX36627063ABBA	383 X 270 X 66	0.2692	6	1.6152
5	保利龍板(4)Polylon board	OTPLB00PL08ABA	550 X 393 X 20	0.0284	2	0.0568
6	外紙箱(5)Carton	BX57041027CCBA	570 X 410 X 265	1.4208	1	1.4208
7						
8						
9						

2. 一整箱總重量 (Total LCD Weight in carton) : 17.24 Kg±10%

3. 單箱數量規格表 (Packaging Specifications and Quantity) :

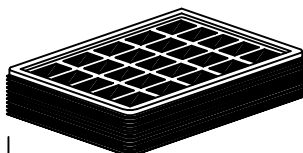
(1) LCM quantity per box : no per tray	6	x no of tray	8	=	48
(2) Total LCM quantity in carton : quantity per box	48	x no of boxes	6	=	288

Use empty tray
空盤



+

Put products into the tray

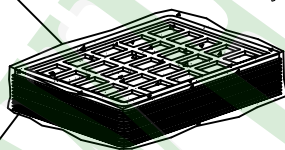


↓

Tray stacking

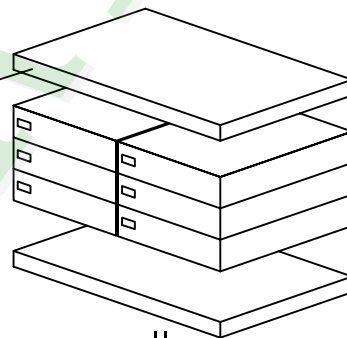


(1) 多層薄膜
POF

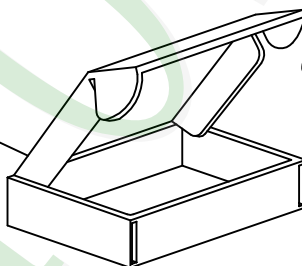


(2) TRAY 盤
Tray

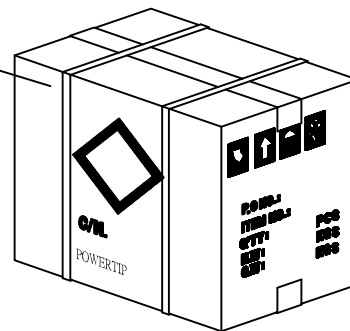
(4) 保利龍板
Polylon board



(3) 內盒
Product Box



(5) 外紙箱
Carton

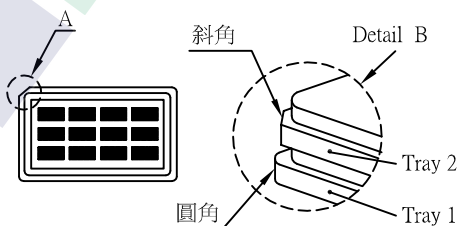


特 記 事 項 (REMARK)

4. Label Specifications :

TYPE			
ID.NO	S/O		
Q'TY	Pcs	Date	
Lot.NO			
Note			

參照"成品包裝點檢作業標準書"內容



5. TRAY盤相疊時,需旋轉180度,請詳見B視圖
Rotate tray 180 degrees and place on top of stack.
Check the tray stack using Fig. B.

6. Tray料號:
Tray Number:PH320240T-001